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PRODUCT NUMBER
95609-XXXLF

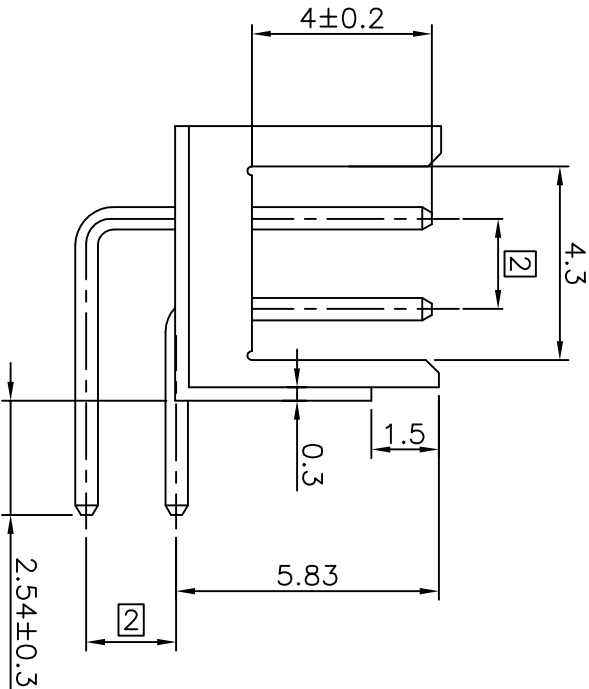
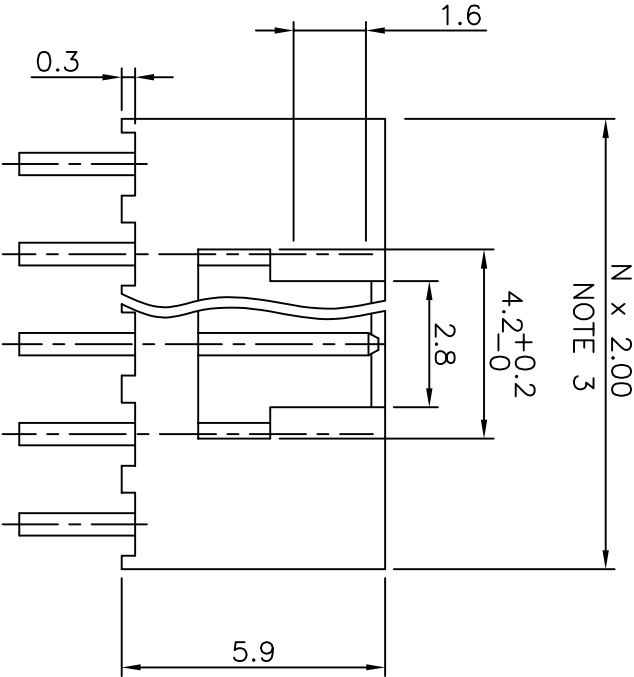
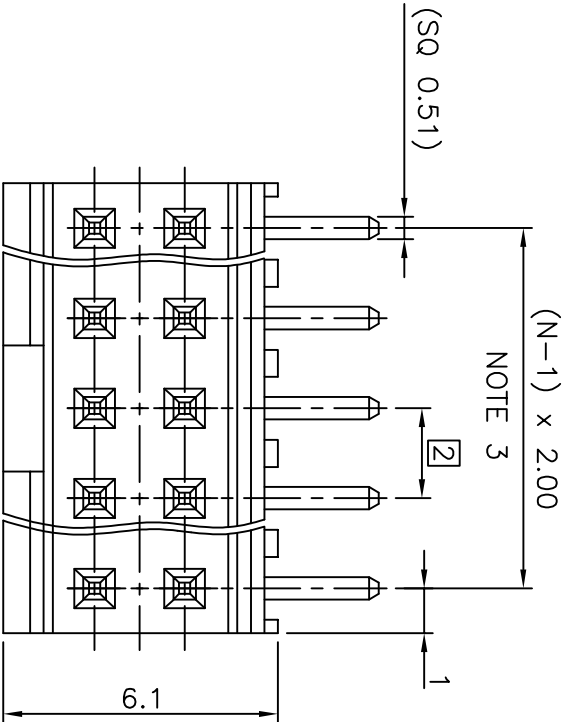
PLATING _____ RoHS COMPATIBLE, SEE NOTE 6

- 0 = 0.20µm Au/GXT
- 1 = 0.76µm Au/GXT
- 3 = 0.38µm Au/GXT
- 5 = 0.38µm GXT
- 6 = 0.76µm GXT

1.27µm Ni MIN UNDERPLATING

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. STANDARD PACKAGING IN POLYBAGS.
6. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - b - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - c - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-47-0004



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form: A3

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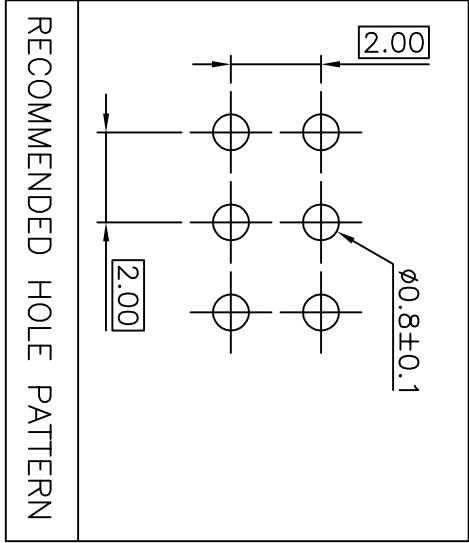
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mat'l. code				surface		tolerance		projection		product family			
SEE NOTES				ISO 1302	✓	ISO 406	ISO 150	1101		MINITEK HEADER			
ltr	ecn no	dr	date	tolerances unless otherwise specified						title			
C	F05-0128	LMU	05.02.21	angles	linear	.X ±0.3				SHR HEADER			
D	F06-0210	LMU	06.07.04			.XX ±0.13				2.00mm TMT R/A			
E	F08-0145	ELA	15.04.08	±2°		.XXX ±0.05		scale 7:1		dwg no			
F	B-19190	LMU	14.10.24	dr	L.MULIN	02.06.19				sheet 1 of 1			
				eng J. COMPAGNON		02.06.19				95609		size	
				chr						A3			
				appd		JMC		02.06.19		type			
sheet index		revision sheet								CUSTOMER Drawing			